

SKNa 86, SKRa 86



Stud Diode

V_{RSM} V	$V_{(BR)min}$ V	$I_{FRMS} = 185 \text{ A}$ (maximum value for continuous operation) $I_{FAV} = 85 \text{ A}$ (sin. 180; $T_C = 130 \text{ }^\circ\text{C}$)	
1400	1400	SKNa 86/14	SKRa 86/14
1800	1800	SKNa 86/18	SKRa 86/18
2000	2000	SKNa 86/20	SKRa 86/20

Avalanche Diodes

SKNa 86
SKRa 86

Features

- Avalanche type reverse characteristic of 2000 V
- Hermetic metal cases with glass insulator
- Threaded studs ISO M8 or 1/4"-28 UNF-2A²⁾
- **SKN**: anode to stud
- **SKR**: cathode to stud

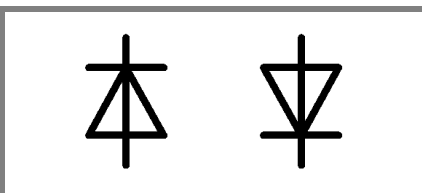
Typical Applications

- DC supply for magnets or solenoids (brakes, valves, etc.)
- Field coil supply for DC motors
- Series connections for high voltage applications like dust precipitators

1) Mounting with grease-like thermal compound or joint contact compound

2) M8x1,25 is standard; "UNF" should be added in description for 1/4"-28 UNF 2A.

Symbol	Condition	Values	Units
I_{FAV}	sin. 180 ; $T_C = 100 \text{ }^\circ\text{C}$	115	A
I_{FSM}	$T_{vj} = 25^\circ \text{C}$; 10 ms $T_{vj} = 180^\circ \text{C}$; 10 ms	1500 1275	A A
i^2t	$T_{vj} = 25^\circ \text{C}$; 8,3...10 ms $T_{vj} = 180^\circ \text{C}$; 8,3...10 ms	11250 8125	A ² s A ² s
V_F	$T_{vj} = 25^\circ \text{C}$, $I_F = 150 \text{ A}$	max. 1,3	V
$V_{(TO)}$	$T_{vj} = 180^\circ \text{C}$	0,85	V
r_T	$T_{vj} = 180^\circ \text{C}$	3	mΩ
I_R	$T_{vj} = 180^\circ \text{C}$; $V_R = V_{(BR)min}$	10	mA
P_{RSM}	$T_{vj} = 180^\circ\text{C}$, $t_P = 10 \mu\text{s}$	20	kW
$R_{th(j-c)}$		0,4	K/W
$R_{th(c-s)}$		0,2	K/W
T_{vj}		-40...+180	$^\circ\text{C}$
T_{stg}		-40...+180	$^\circ\text{C}$
V_{isol}		-	V~
M_s	M8 Stud	4	Nm
	1/4"-28 UNF 2A	2,5	Nm
	M8 Stud (lubricated) ¹⁾	3	Nm
	1/4"-28 UNF 2A (lubricated) ¹⁾	2	Nm
a		5 * 9,81	m/s ²
m	approx.	20	g
Case		E 10	



SKN

SKR

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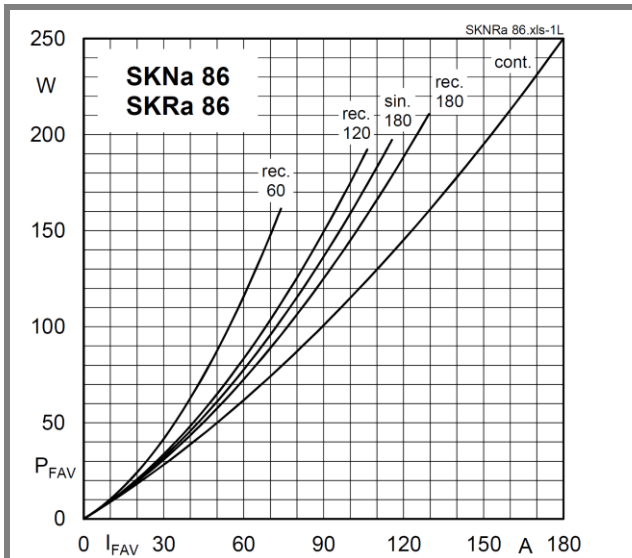


Fig. 1L Power dissipation vs. forward current

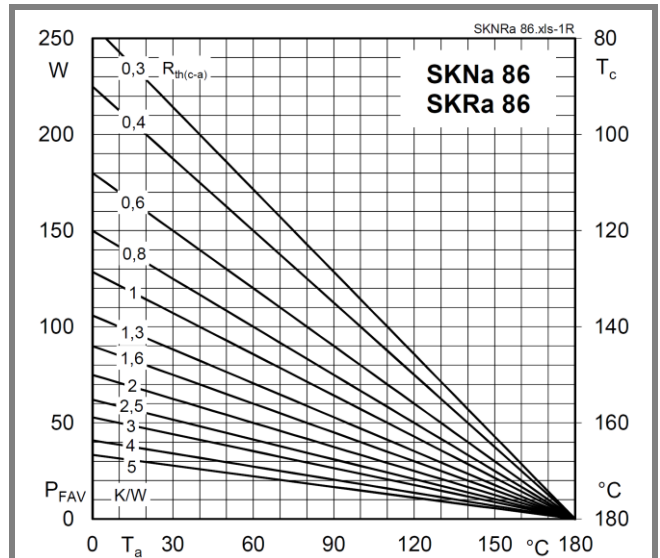


Fig. 1R Power dissipation vs. ambient temperature

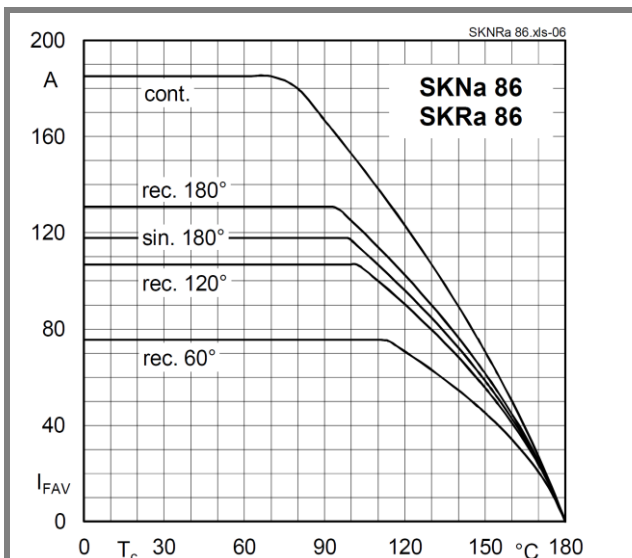


Fig. 2 Forward current vs. case temperature

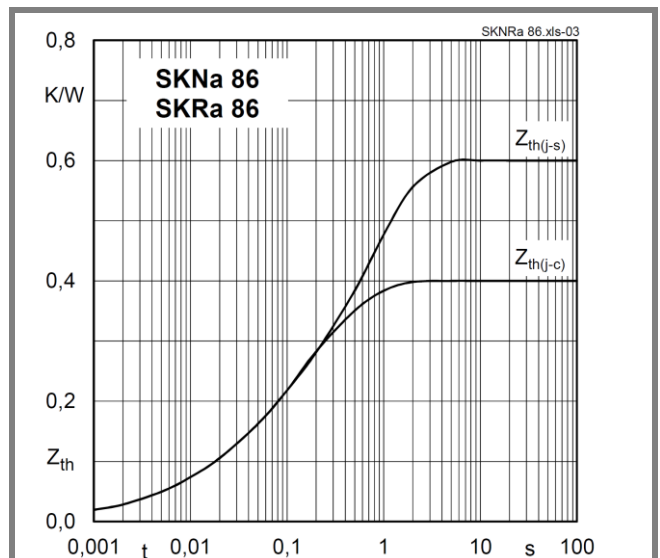


Fig. 4 Transient thermal impedance vs. time

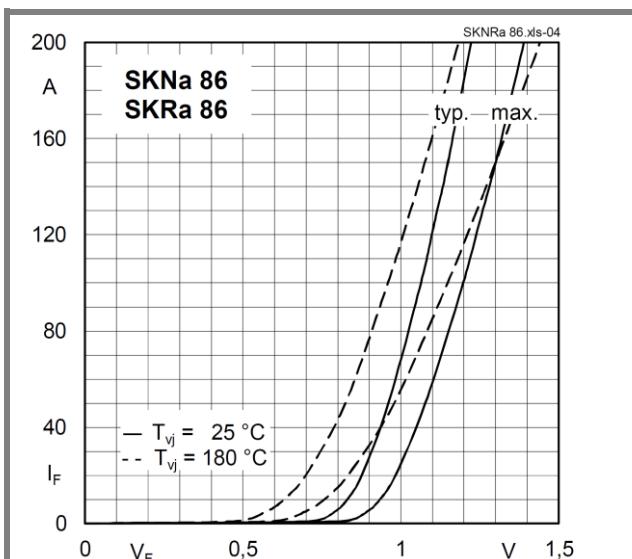


Fig. 5 Forward characteristics

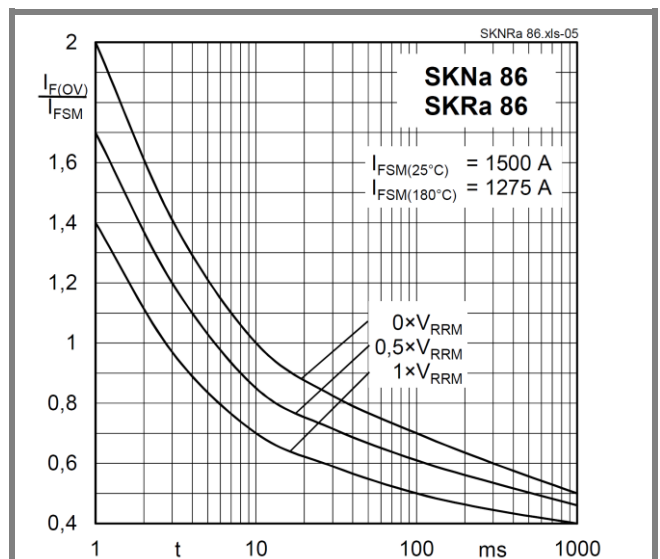
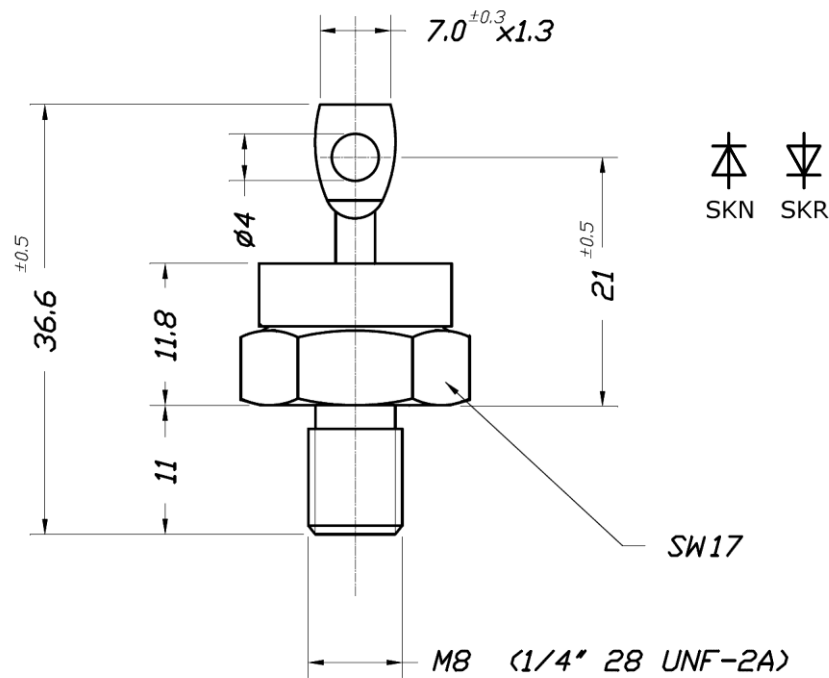


Fig. 6 Surge overload current vs. time



Case E10 (JEDEC: DO-203 AB (DO-5))

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